

C0805C152J2GEC

ESD SMD Comm COG, Ceramic, 1,500 pF, 5%, 200 VDC, COG, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 0805, 0.7 mm



General Information	
Series	ESD SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I
Features	Temperature Stable, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	11 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
Т	0.78mm +/-0.10mm
S	0.7mm MIN
В	0.5mm +/-0.25mm

S	0.7mm MIN
В	0.5mm +/-0.25mm
Packaging Specifications	
Packaging	Bulk, Bag

Packaging Quantity

00 - F
00 pF
Hz 1.0Vrms
0 VDC
000 V ESD Level
0 VDC
5/+125°C
)G
ppm/C, 1kHz 1.0Vrms
%1kHz1.0Vrms
Loss/Decade Hour
O GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - an	ıd
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